



Receipt #6

**PATENT**  
Docket No. 420099-654  
LSI Ref. P-2880/1D

I hereby certify that this correspondence is being deposited on December 29, 1997 with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

*Cheryle A. Healion*

Cheryle A. Healion

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of

Mike Liang

Entitled: **FLIP CHIP BUMP  
DISTRIBUTION ON DIE**

Serial No.: 08/909,312

Filed: August 14, 1997

Group Art Unit: 1104

Examiner:

**RECEIVED**  
MAR 02 1998  
**GROUP 2100**

Assistant Commissioner for Patents  
Washington, D.C. 20231  
Attn: Application Processing Division  
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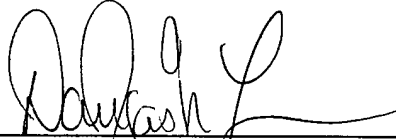
**FILING RECEIPT CORRECTION**

Sir:

Please correct the filing receipt (copy enclosed and corrections indicated in red) related to the above-referenced patent application. The Filing Date as shown on the filing receipt is "08/11/97" and should be changed to indicate the correct Filing Date as --08/14/97--.

**PATENT**  
Docket No. 420099-654  
LSI Ref. P-2880/1D

Respectfully submitted,



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Douglas N. Larson  
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Dated: December 29, 1997

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FILING RECEIPT



UNITED STATES DEPARTMENT OF COMMERCE  
Patent and Trademark Office  
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTORNEY DOCKET NO.	DRWGS	TOT CL	IND CL
08/909,312	08/11/97	1104	\$770.00	420099-654	10	4	2

*DNL 14*  
POMS SMITH LANDE & ROSE  
2029 CENTURY PARK EAST 38TH FLOOR  
LOS ANGELES CA 90067-3024  
*LSI Logic*

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Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Application Processing Division's Customer Correction Branch within 10 days of receipt. Please provide a copy of the Filing Receipt with the changes noted thereon.

Applicant(s)

MIKE LIANG, MILPITAS, CA.

CONTINUING DATA AS CLAIMED BY APPLICANT-

THIS APPLN IS A DIV OF 08/747,325 11/12/96

FOREIGN FILING LICENSE GRANTED 12/12/97

TITLE

FLIP CHIP BUMP DISTRIBUTION ON DIE

PRELIMINARY CLASS: 438